

| L Number | Hits | Search Text | DB | Time stamp |
|----------|------|--|---|------------------|
| - | 8 | ohkura.in. and ryoichi.in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:19 |
| - | 1160 | ono.in. and yuji.in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:19 |
| - | 74 | (ono.in. and yuji.in.) and semiconductor | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:20 |
| - | 45 | (ono.in. and yuji.in.) and (semiconductor or wafer or substrate).ti. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:22 |
| - | 6289 | yamaguchi.in. and hiroshi.in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:22 |
| - | 303 | (yamaguchi.in. and hiroshi.in.) and (semiconductor or wafer or substrate).ti. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:25 |
| - | 10 | ((yamaguchi.in. and hiroshi.in.) and (semiconductor or wafer or substrate).ti.) and (ohkura or ono or takaishi or kamikochi).in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:27 |
| - | 1787 | takaishi.in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:25 |
| - | 171 | takaishi.in. and (semiconductor or wafer or substrate).ti. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:25 |
| - | 171 | (takaishi.in. and (semiconductor or wafer or substrate).ti.) and (ohkura or ono or takaishi or kamikochi).in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 14:25 |
| - | 2 | ((takaishi.in. and (semiconductor or wafer or substrate).ti.) and (ohkura or ono or takaishi or kamikochi).in.) and booth | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 15:24 |
| - | 3249 | 134/61-83.ccls. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 15:47 |

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|---|------|--|---|------------------|
| - | 15 | 134/61-83.ccls. and (robot adj arm) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 15:48 |
| - | 14 | 134/61-83.ccls. and booth | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 15:46 |
| - | 1854 | 134/902.ccls. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 16:12 |
| - | 64 | 134/902.ccls. and (robot adj arm) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 16:12 |
| - | 26 | (134/902.ccls. and (robot adj arm)) and (load\$3 and unload\$3) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 16:13 |
| - | 2914 | 134/61,66,78,200,902.ccls. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 16:12 |
| - | 71 | 134/61,66,78,200,902.ccls. and (robot adj arm) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 16:12 |
| - | 26 | (134/61,66,78,200,902.ccls. and (robot adj arm)) and (load\$3 and unload\$3) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/02/26 16:13 |